

Technical Data Sheet Infrared MIDLED LED IR89-01C/L447/1R



Features

- Low forward voltage.
- View angle 30°(Typ.)
- Pb free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)

Description

- IR89-01C/L447/1R is an infrared emitting diode with miniature MIDLED package. The device is spectrally matched with silicon photodiode and phototransistor

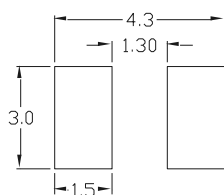
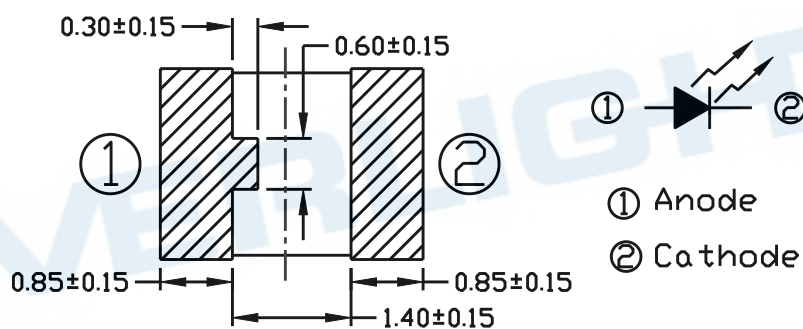
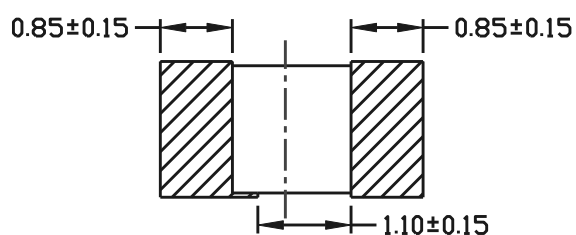
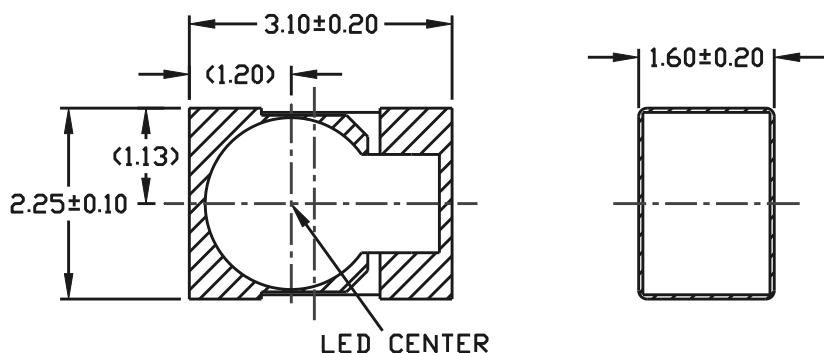
Applications

- Infrared applied system

Device Selection Guide

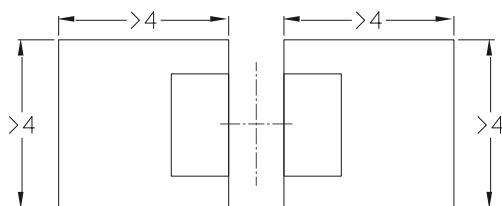
Device No.	Chip Material	Lens Color
IR89-01C/L447/1R	GaAlAs	Water clear


Package Dimensions



soldering pattern for top layer

Cu pad for heat dissipation



 solder resist

- Notes:** 1.All dimensions are in millimeters
2.Tolerances unless dimensions $\pm 0.1\text{mm}$

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Continuous Forward Current	I _F	80	mA
Peak Forward Current *1	I _{FP}	800	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-40 ~ +100	°C
Storage Temperature	T _{stg}	-40 ~ +100	°C
Soldering Temperature *2	T _{sol}	260	°C
Power Dissipation at(or below) 25°C Free Air Temperature	P _d	170	mW

Notes: *1: I_{FP} Conditions--Pulse Width ≤ 100μ s and Duty ≤ 1%.

*2: Soldering time ≤ 5 seconds.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Radiant Intensity	I _e	40	60	125	mW /sr	I _F =70mA
		45	70	--		I _F =100mA Pulse Width ≤ 100μ s ,Duty ≤ 1%
Peak Wavelength	λ _p	--	940	--	nm	I _F =100mA
Spectral Bandwidth	Δ λ	--	40	--	nm	I _F =100mA
Forward Voltage	V _F	--	1.75	2.2	V	I _F =100mA
Reverse Current	I _R	--	--	10	μ A	V _R =5V
View Angle	2θ1/2	--	30	--	deg	I _F =20mA

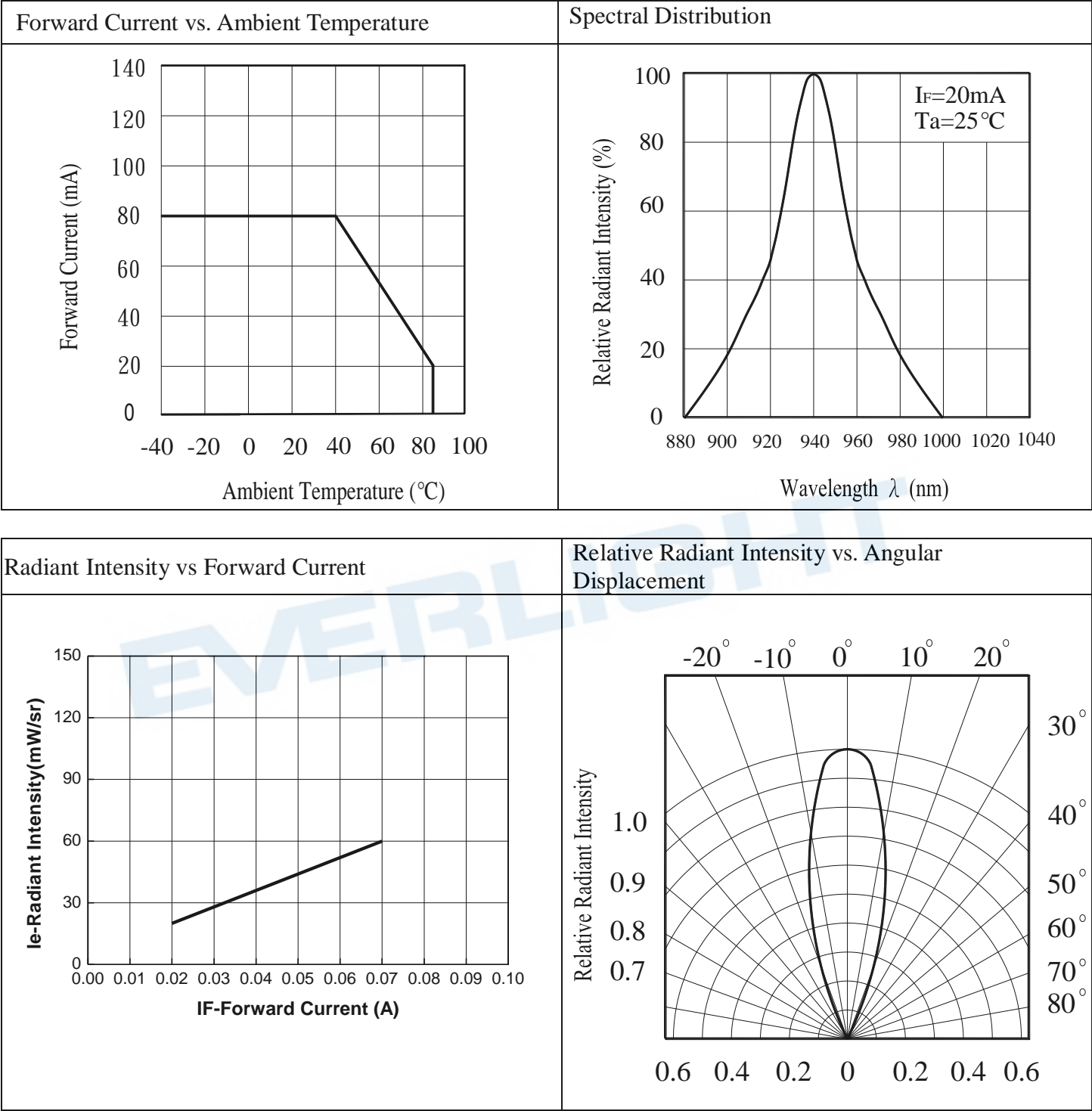
Rank

Condition : I_F=70mA

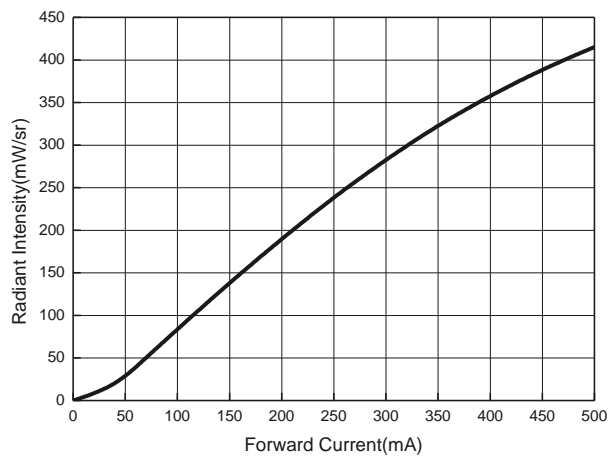
Unit : mW/sr

Bin Number	C	D
Min	40	63
Max	80	125

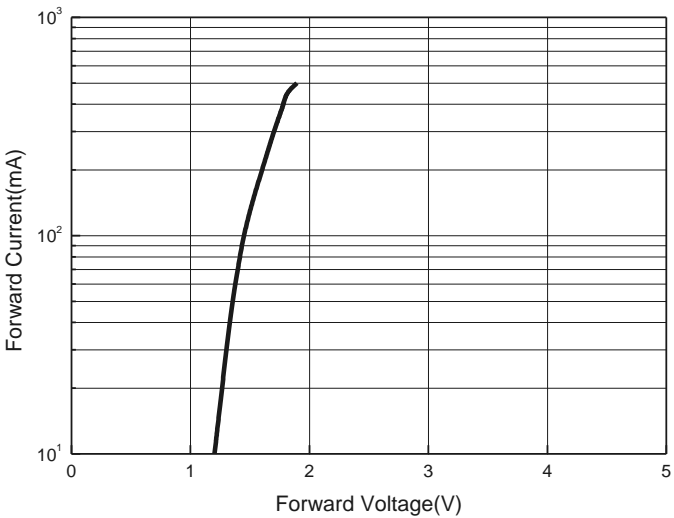
Typical Electrical/Optical/Characteristics Curves for IR



Radiant Intensity vs Forward Current (pulse)



Forward Current vs Forward Voltage



EVERLIGHT

● Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before devices are ready to use.

2.2 Shelf life in sealed bag from the bag seal date:

18 onths at 10°C~30°C and < 90% RH.

2.3 After opening the package, the devices must be stored at 10°C~30°C and 60%RH, and used within 72 hours(floor life).

2.4 If the moisture absorbent material(desiccant material) has faded or unopened bag has exceeded the shelf life or devices(out of bag) have exceeded the floor life, baking treatment is required.

2.5 If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the following conditions :

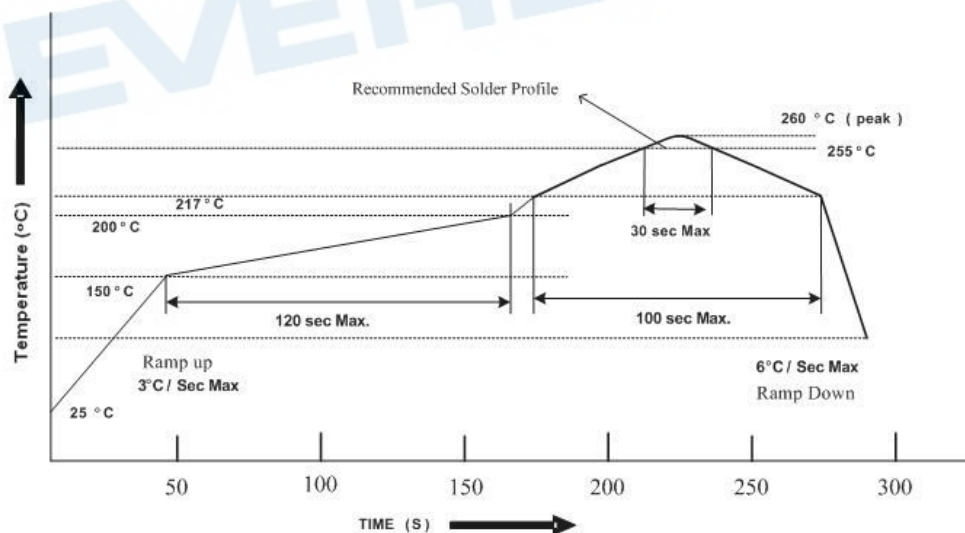
192 hours at 40°C +5/-0°C and < 5 % RH (reeled/tubed/loose units) or

96 hours at 60°C ± 5°C and < 5 % RH (reeled/tubed/loose units) or

24 hours at 125°C ± 5°C, not suitable for reel or tubes.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

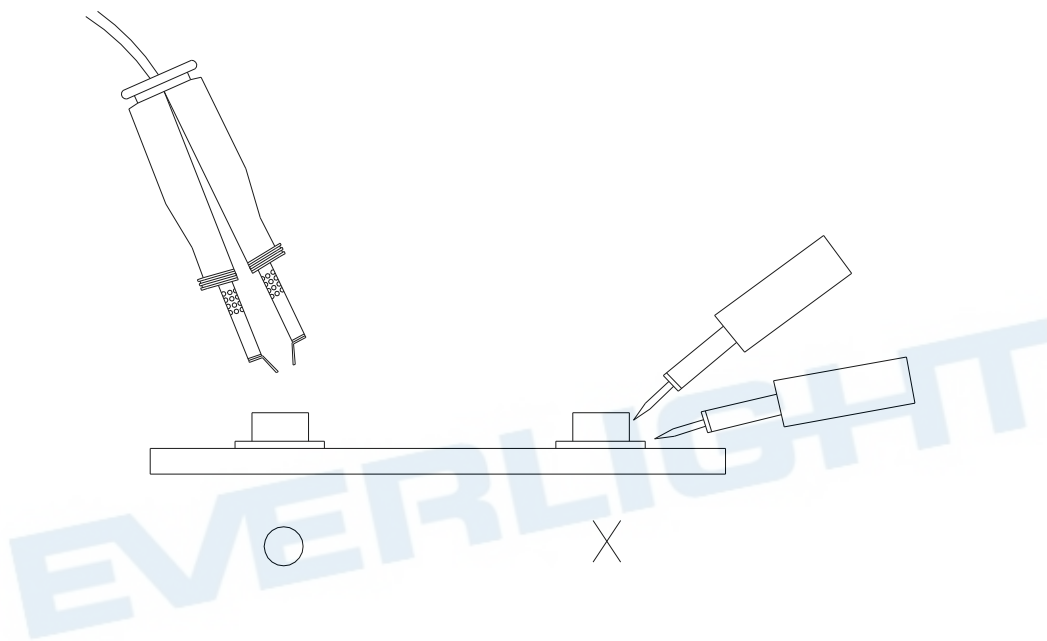
3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



Technical drawing of a circular mechanical part, showing a top view and a side view.

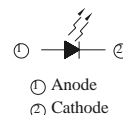
Top View Dimensions:

- Central feature width: 2.2 ± 0.5
- Central feature diameter: $\phi 13.0 \pm 0.5$

Side View Dimensions:

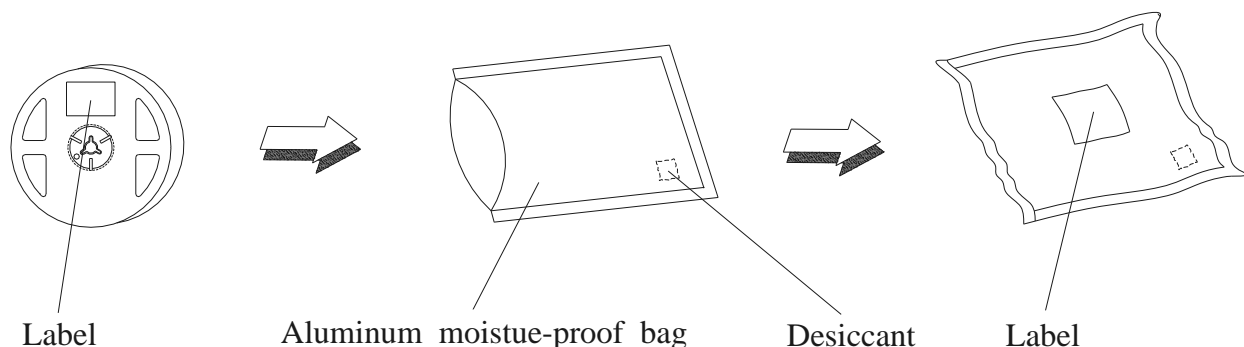
- Overall diameter: $\phi 178.0 \pm 1.0$
- Central feature diameter: $\phi 60.0 \pm 0.5$
- Feature height: 9.0 ± 0.5
- Base thickness: 12.0 ± 0.15

2. Carrier Tape Dimensions:(Quantity: 2000pcs/reel)



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Packing Procedure



Label Form Specification

RoHS		EVERLIGHT	
CPN:			
XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX			
P/N:			
XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXXXXXX-XXXXXX			
LOT NO:			
QTY:			
HUE:			
CAT:		REF:	
REFERENCE:			

CPN: Customer's Production Number
P/N : Production Number
QTY: Packing Quantity
CAT: Ranks
HUE: Peak Wavelength
REF: Reference
LOT No: Lot Number
MADE IN TAIWAN: Production Place

DISCLAIMER

1. EVERLIGHT reserves the right(s) on the adjustment of product material mix for the specification.
2. The product meets EVERLIGHT published specification for a period of twelve (12) months from date of shipment.
3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
4. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from the use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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